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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	25MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	8KB (4K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	454 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c43-25-p

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC17C4X can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC17C4X uses a modified Harvard architecture. This architecture has the program and data accessed from separate memories. So the device has a program memory bus and a data memory bus. This improves bandwidth over traditional von Neumann architecture, where program and data are fetched from the same memory (accesses over the same bus). Separating program and data memory further allows instructions to be sized differently than the 8-bit wide data word. PIC17C4X opcodes are 16-bits wide, enabling single word instructions. The full 16-bit wide program memory bus fetches a 16-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions execute in a single cycle (121 ns @ 33 MHz), except for program branches and two special instructions that transfer data between program and data memory.

The PIC17C4X can address up to 64K x 16 of program memory space.

The **PIC17C42** and **PIC17C42A** integrate 2K x 16 of EPROM program memory on-chip, while the **PIC17CR42** has 2K x 16 of ROM program memory on-chip.

The **PIC17C43** integrates 4K x 16 of EPROM program memory, while the **PIC17CR43** has 4K x 16 of ROM program memory.

The **PIC17C44** integrates 8K x 16 EPROM program memory.

Program execution can be internal only (microcontroller or protected microcontroller mode), external only (microprocessor mode) or both (extended microcontroller mode). Extended microcontroller mode does not allow code protection.

The PIC17CXX can directly or indirectly address its register files or data memory. All special function registers, including the Program Counter (PC) and Working Register (WREG), are mapped in the data memory. The PIC17CXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC17CXX simple yet efficient. In addition, the learning curve is reduced significantly.

One of the PIC17CXX family architectural enhancements from the PIC16CXX family allows two file registers to be used in some two operand instructions. This allows data to be moved directly between two registers without going through the WREG register. This increases performance and decreases program memory usage.

The PIC17CXX devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift, and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature.

The WREG register is an 8-bit working register used for ALU operations.

All PIC17C4X devices (except the PIC17C42) have an 8 x 8 hardware multiplier. This multiplier generates a 16-bit result in a single cycle.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow and digit borrow out bit, respectively, in subtraction. See the **SUBLW** and **SUBWF** instructions for examples.

Although the ALU does not perform signed arithmetic, the Overflow bit (OV) can be used to implement signed math. Signed arithmetic is comprised of a magnitude and a sign bit. The overflow bit indicates if the magnitude overflows and causes the sign bit to change state. Signed math can have greater than 7-bit values (magnitude), if more than one byte is used. The use of the overflow bit only operates on bit6 (MSb of magnitude) and bit7 (sign bit) of the value in the ALU. That is, the overflow bit is not useful if trying to implement signed math where the magnitude, for example, is 11-bits. If the signed math values are greater than 7-bits (15-, 24- or 31-bit), the algorithm must ensure that the low order bytes ignore the overflow status bit.

Care should be taken when adding and subtracting signed numbers to ensure that the correct operation is executed. Example 3-1 shows an item that must be taken into account when doing signed arithmetic on an ALU which operates as an unsigned machine.

EXAMPLE 3-1: SIGNED MATH

Hex Value	Signed Value Math	Unsigned Value Math
FFh	-127	255
+ 01h	+ 1	+ 1
= ?	= -126 (FEh)	= 0 (00h); Carry bit = 1

Signed math requires the result in REG to be FEh (-126). This would be accomplished by subtracting one as opposed to adding one.

Simplified block diagrams are shown in Figure 3-1 and Figure 3-2. The descriptions of the device pins are listed in Table 3-1.

FIGURE 4-2: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ TIED TO V_{DD})

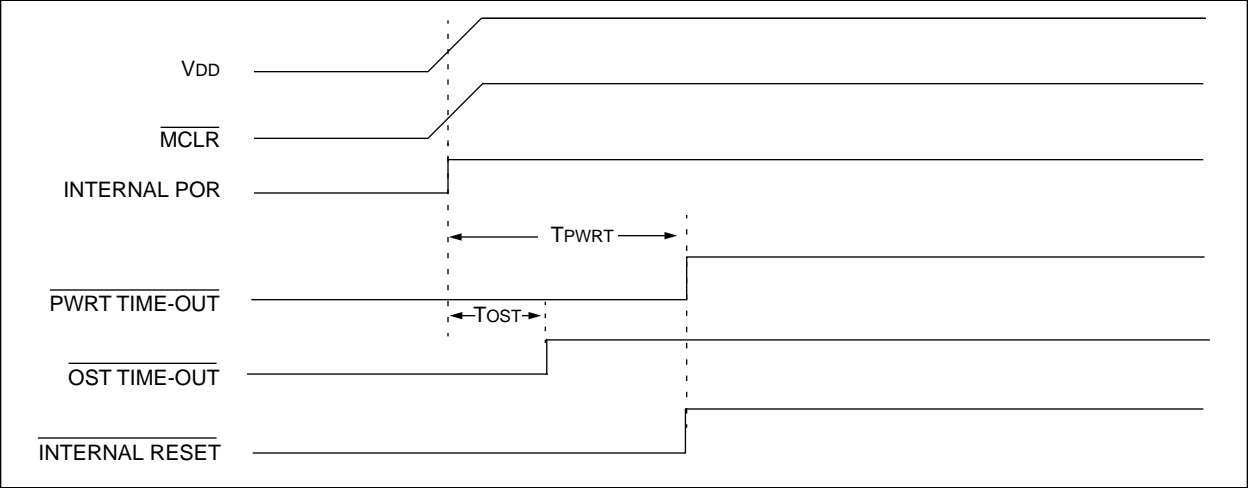


FIGURE 4-3: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD})

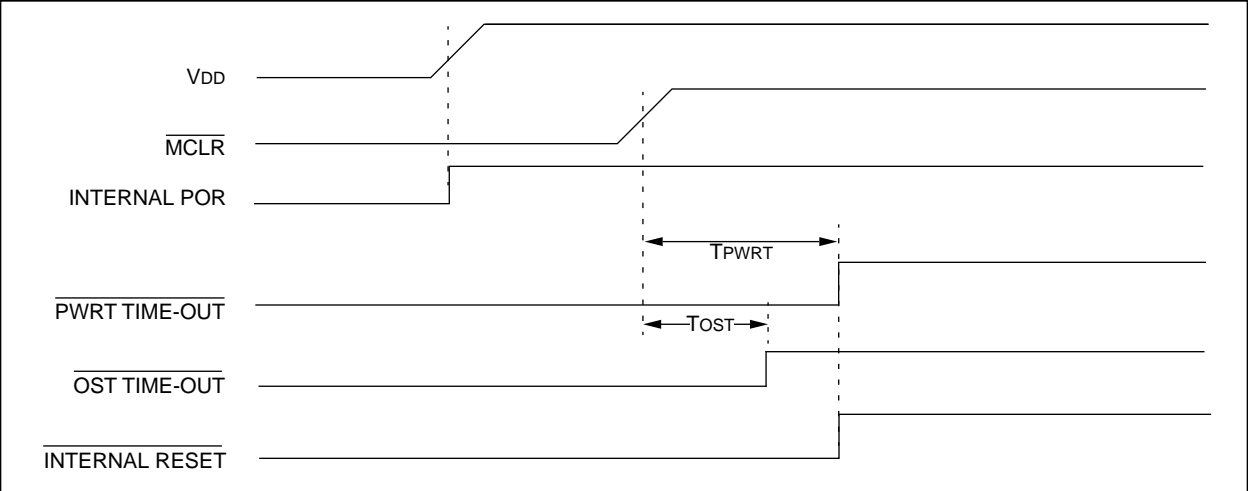


FIGURE 4-4: SLOW RISE TIME ($\overline{\text{MCLR}}$ TIED TO V_{DD})

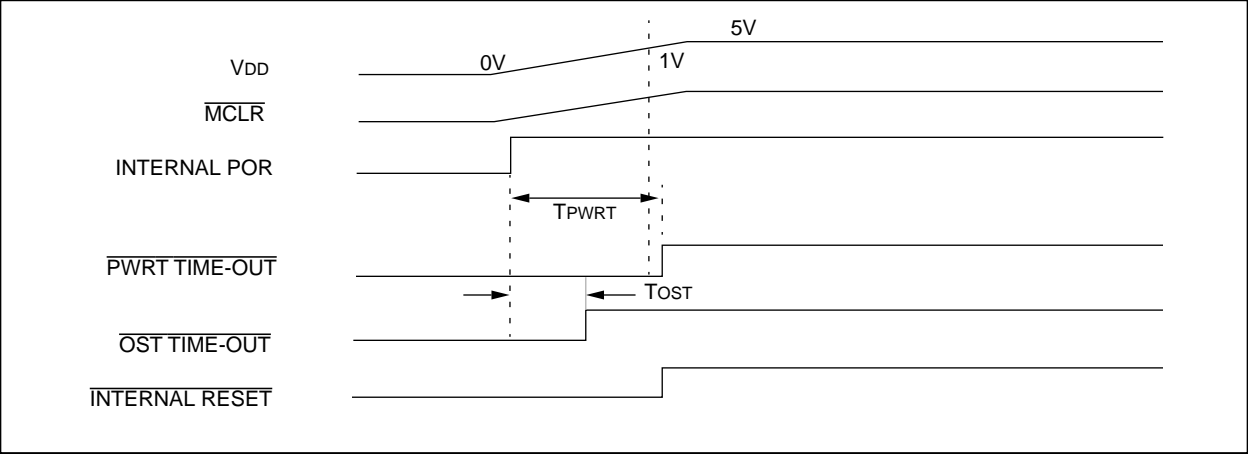


TABLE 4-4: INITIALIZATION CONDITIONS FOR SPECIAL FUNCTION REGISTERS

Register	Address	Power-on Reset	MCLR Reset WDT Reset	Wake-up from SLEEP through interrupt
Unbanked				
INDF0	00h	0000 0000	0000 0000	0000 0000
FSR0	01h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	02h	0000h	0000h	PC + 1 ⁽²⁾
PCLATH	03h	0000 0000	0000 0000	uuuu uuuu
ALUSTA	04h	1111 xxxx	1111 uuuu	1111 uuuu
T0STA	05h	0000 000-	0000 000-	0000 000-
CPUSTA ⁽³⁾	06h	--11 11--	--11 qq--	--uu qq--
INTSTA	07h	0000 0000	0000 0000	uuuu uuuu ⁽¹⁾
INDF1	08h	0000 0000	0000 0000	uuuu uuuu
FSR1	09h	xxxx xxxx	uuuu uuuu	uuuu uuuu
WREG	0Ah	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR0L	0Bh	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR0H	0Ch	xxxx xxxx	uuuu uuuu	uuuu uuuu
TBLPTRL ⁽⁴⁾	0Dh	xxxx xxxx	uuuu uuuu	uuuu uuuu
TBLPTRH ⁽⁴⁾	0Eh	xxxx xxxx	uuuu uuuu	uuuu uuuu
TBLPTRL ⁽⁵⁾	0Dh	0000 0000	0000 0000	uuuu uuuu
TBLPTRH ⁽⁵⁾	0Eh	0000 0000	0000 0000	uuuu uuuu
BSR	0Fh	0000 0000	0000 0000	uuuu uuuu
Bank 0				
PORTA	10h	0-xx xxxx	0-uu uuuu	uuuu uuuu
DDRB	11h	1111 1111	1111 1111	uuuu uuuu
PORTB	12h	xxxx xxxx	uuuu uuuu	uuuu uuuu
RCSTA	13h	0000 -00x	0000 -00u	uuuu -uuu
RCREG	14h	xxxx xxxx	uuuu uuuu	uuuu uuuu
TXSTA	15h	0000 --1x	0000 --1u	uuuu --uu
TXREG	16h	xxxx xxxx	uuuu uuuu	uuuu uuuu
SPBRG	17h	xxxx xxxx	uuuu uuuu	uuuu uuuu
Bank 1				
DDRC	10h	1111 1111	1111 1111	uuuu uuuu
PORTC	11h	xxxx xxxx	uuuu uuuu	uuuu uuuu
DDRD	12h	1111 1111	1111 1111	uuuu uuuu
PORTD	13h	xxxx xxxx	uuuu uuuu	uuuu uuuu
DDRE	14h	---- -111	---- -111	---- -uuu
PORTE	15h	---- -xxx	---- -uuu	---- -uuu
PIR	16h	0000 0010	0000 0010	uuuu uuuu ⁽¹⁾
PIE	17h	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented read as '0', q = value depends on condition.

Note 1: One or more bits in INTSTA, PIR will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GLINTD bit is cleared, the PC is loaded with the interrupt vector.

3: See Table 4-3 for reset value of specific condition.

4: Only applies to the PIC17C42.

5: Does not apply to the PIC17C42.

9.4 PORTD and DDRD Registers

PORTD is an 8-bit bi-directional port. The corresponding data direction register is DDRD. A '1' in DDRD configures the corresponding port pin as an input. A '0' in the DDRC register configures the corresponding port pin as an output. Reading PORTD reads the status of the pins, whereas writing to it will write to the port latch. PORTD is multiplexed with the system bus. When operating as the system bus, PORTD is the high order byte of the address/data bus (AD15:AD8). The timing for the system bus is shown in the Electrical Characteristics section.

Note: This port is configured as the system bus when the device's configuration bits are selected to Microprocessor or Extended Microcontroller modes. In the two other microcontroller modes, this port is a general purpose I/O.

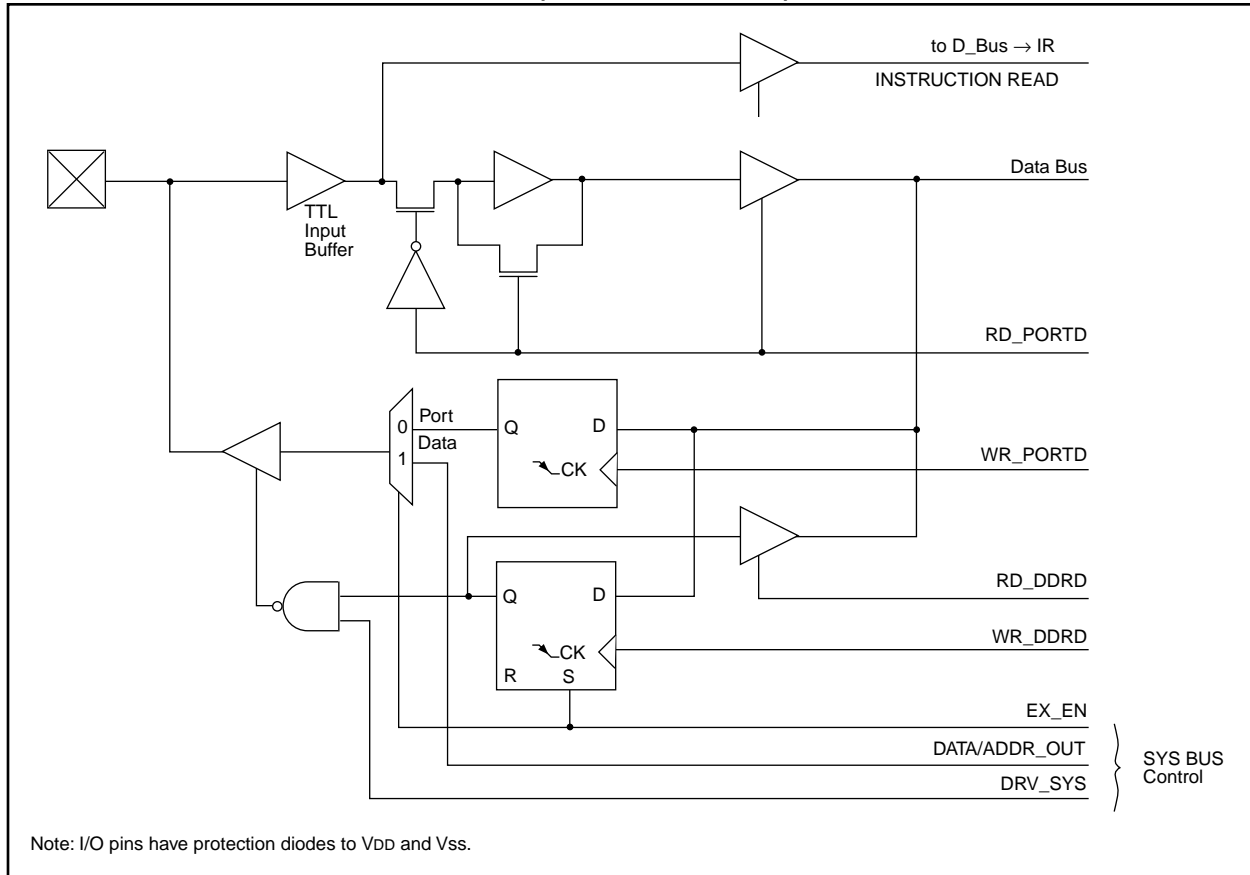
Example 9-3 shows the instruction sequence to initialize PORTD. The Bank Select Register (BSR) must be selected to Bank 1 for the port to be initialized.

EXAMPLE 9-3: INITIALIZING PORTD

```

MOVLB 1           ; Select Bank 1
CLRF  PORTD       ; Initialize PORTD data
                  ; latches before setting
                  ; the data direction
                  ; register
MOVLW 0xCF        ; Value used to initialize
                  ; data direction
MOVWF DDRD        ; Set RD<3:0> as inputs
                  ; RD<5:4> as outputs
                  ; RD<7:6> as inputs
    
```

FIGURE 9-7: PORTD BLOCK DIAGRAM (IN I/O PORT MODE)



9.4.1 PORTE AND DDRE REGISTER

PORTE is a 3-bit bi-directional port. The corresponding data direction register is DDRE. A '1' in DDRE configures the corresponding port pin as an input. A '0' in the DDRE register configures the corresponding port pin as an output. Reading PORTE reads the status of the pins, whereas writing to it will write to the port latch. PORTE is multiplexed with the system bus. When operating as the system bus, PORTE contains the control signals for the address/data bus (AD15:AD0). These control signals are Address Latch Enable (ALE), Output Enable (\overline{OE}), and Write (\overline{WR}). The control signals \overline{OE} and \overline{WR} are active low signals. The timing for the system bus is shown in the Electrical Characteristics section.

Note: This port is configured as the system bus when the device's configuration bits are selected to Microprocessor or Extended Microcontroller modes. In the two other microcontroller modes, this port is a general purpose I/O.

Example 9-4 shows the instruction sequence to initialize PORTE. The Bank Select Register (BSR) must be selected to Bank 1 for the port to be initialized.

EXAMPLE 9-4: INITIALIZING PORTE

```

MOVLB 1           ; Select Bank 1
CLRF  PORTE       ; Initialize PORTE data
                  ; latches before setting
                  ; the data direction
                  ; register
MOVLW 0x03        ; Value used to initialize
                  ; data direction
MOVWF DDRE        ; Set RE<1:0> as inputs
                  ; RE<2> as outputs
                  ; RE<7:3> are always
                  ; read as '0'
    
```

FIGURE 9-8: PORTE BLOCK DIAGRAM (IN I/O PORT MODE)

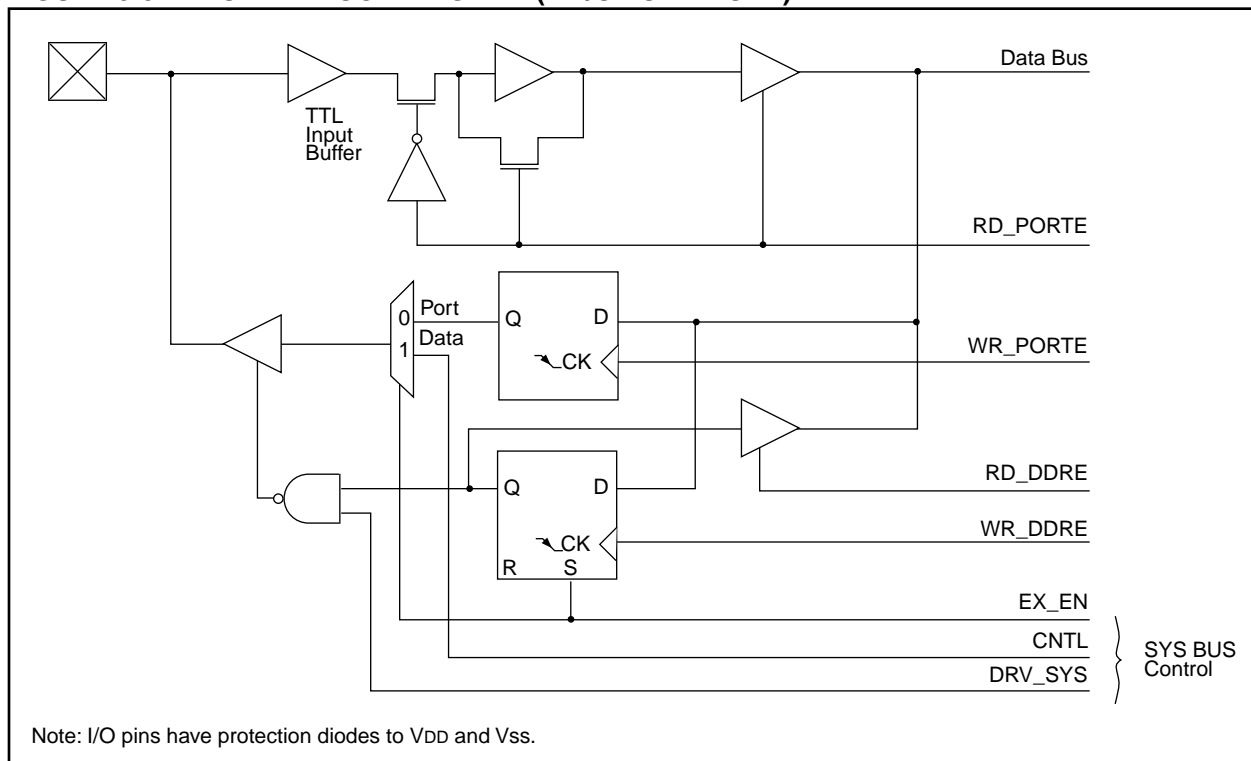


TABLE 9-9: PORTE FUNCTIONS

Name	Bit	Buffer Type	Function
RE0/ALE	bit0	TTL	Input/Output or system bus Address Latch Enable (ALE) control pin.
RE1/ \overline{OE}	bit1	TTL	Input/Output or system bus Output Enable (\overline{OE}) control pin.
RE2/ \overline{WR}	bit2	TTL	Input/Output or system bus Write (\overline{WR}) control pin.

Legend: TTL = TTL input.

TABLE 9-10: REGISTERS/BITS ASSOCIATED WITH PORTE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
15h, Bank 1	PORTE	—	—	—	—	—	RE2/ \overline{WR}	RE1/ \overline{OE}	RE0/ALE	---- -xxx	---- -uuu
14h, Bank 1	DDRE	Data direction register for PORTE								---- -111	---- -111

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by PORTE.

Note 1: Other (non power-up) resets include: external reset through \overline{MCLR} and the Watchdog Timer Reset.

ADDLW

ADD Literal to WREG

Syntax: [*label*] ADDLW k

Operands: $0 \leq k \leq 255$

Operation: (WREG) + k → (WREG)

Status Affected: OV, C, DC, Z

Encoding:

1011	0001	kkkk	kkkk
------	------	------	------

Description: The contents of WREG are added to the 8-bit literal 'k' and the result is placed in WREG.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Execute	Write to WREG

Example: ADDLW 0x15

Before Instruction
WREG = 0x10

After Instruction
WREG = 0x25

ADDWF

ADD WREG to f

Syntax: [*label*] ADDWF f,d

Operands: $0 \leq f \leq 255$
 $d \in [0,1]$

Operation: (WREG) + (f) → (dest)

Status Affected: OV, C, DC, Z

Encoding:

0000	111d	ffff	ffff
------	------	------	------

Description: Add WREG to register 'f'. If 'd' is 0 the result is stored in WREG. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

Example: ADDWF REG, 0

Before Instruction
WREG = 0x17
REG = 0xC2

After Instruction
WREG = 0xD9
REG = 0xC2

MOVLR		Move Literal to high nibble in BSR							
Syntax:	[<i>label</i>] MOVLR k								
Operands:	0 ≤ k ≤ 15								
Operation:	k → (BSR<7:4>)								
Status Affected:	None								
Encoding:	<table><tr><td>1011</td><td>101x</td><td>kkkk</td><td>uuuu</td></tr></table>					1011	101x	kkkk	uuuu
1011	101x	kkkk	uuuu						
Description:	The 4-bit literal 'k' is loaded into the most significant 4-bits of the Bank Select Register (BSR). Only the high 4-bits of the Bank Select Register are affected. The lower half of the BSR is unchanged. The assembler will encode the "u" fields as 0.								
Words:	1								
Cycles:	1								
Q Cycle Activity:									
	Q1	Q2	Q3	Q4					
	Decode	Read literal 'k:u'	Execute	Write literal 'k' to BSR<7:4>					

Example: MOVLR 5

Before Instruction

BSR register = 0x22

After Instruction

BSR register = 0x52

Note: This instruction is not available in the PIC17C42 device.

MOVLW		Move Literal to WREG						
Syntax:	[<i>label</i>] MOVLW k							
Operands:	$0 \leq k \leq 255$							
Operation:	$k \rightarrow (\text{WREG})$							
Status Affected:	None							
Encoding:	<table border="1"><tr><td>1011</td><td>0000</td><td>kkkk</td><td>kkkk</td></tr></table>				1011	0000	kkkk	kkkk
1011	0000	kkkk	kkkk					
Description:	The eight bit literal 'k' is loaded into WREG.							
Words:	1							
Cycles:	1							
Q Cycle Activity:								
	Q1	Q2	Q3	Q4				
	Decode	Read literal 'k'	Execute	Write to WREG				

Example: MOVLW 0x5A

After Instruction

WREG = 0x5A

PIC17C4X

TABLRD Table Read

Example1: TABLRD 1, 1, REG ;

Before Instruction

REG = 0x53
TBLATH = 0xAA
TBLATL = 0x55
TBLPTR = 0xA356
MEMORY(TBLPTR) = 0x1234

After Instruction (table write completion)

REG = 0xAA
TBLATH = 0x12
TBLATL = 0x34
TBLPTR = 0xA357
MEMORY(TBLPTR) = 0x5678

Example2: TABLRD 0, 0, REG ;

Before Instruction

REG = 0x53
TBLATH = 0xAA
TBLATL = 0x55
TBLPTR = 0xA356
MEMORY(TBLPTR) = 0x1234

After Instruction (table write completion)

REG = 0x55
TBLATH = 0x12
TBLATL = 0x34
TBLPTR = 0xA356
MEMORY(TBLPTR) = 0x1234

TABLWT Table Write

Syntax: [label] TABLWT t,i,f

Operands: $0 \leq f \leq 255$
 $i \in [0,1]$
 $t \in [0,1]$

Operation: If $t = 0$,
 $f \rightarrow \text{TBLATL}$;
If $t = 1$,
 $f \rightarrow \text{TBLATH}$;
 $\text{TBLAT} \rightarrow \text{Prog Mem (TBLPTR)}$;
If $i = 1$,
 $\text{TBLPTR} + 1 \rightarrow \text{TBLPTR}$

Status Affected: None

Encoding:

1010	11ti	ffff	ffff
------	------	------	------

Description:

1. Load value in 'f' into 16-bit table latch (TBLAT)
If $t = 0$: load into low byte;
If $t = 1$: load into high byte
2. The contents of TBLAT is written to the program memory location pointed to by TBLPTR
If TBLPTR points to external program memory location, then the instruction takes two-cycle
If TBLPTR points to an internal EPROM location, then the instruction is terminated when an interrupt is received.

Note: The $\overline{\text{MCLR}}$ /VPP pin must be at the programming voltage for successful programming of internal memory.
If $\overline{\text{MCLR}}$ /VPP = VDD
the programming sequence of internal memory will be executed, but will not be successful (although the internal memory location may be disturbed)

3. The TBLPTR can be automatically incremented
If $i = 0$; TBLPTR is not incremented
If $i = 1$; TBLPTR is incremented

Words: 1

Cycles: 2 (many if write is to on-chip EPROM program memory)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register TBLATH or TBLATL

16.6 PICDEM-1 Low-Cost PIC16/17 Demonstration Board

The PICDEM-1 is a simple board which demonstrates the capabilities of several of Microchip's microcontrollers. The microcontrollers supported are: PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The users can program the sample microcontrollers provided with the PICDEM-1 board, on a PRO MATE II or PICSTART-16B programmer, and easily test firmware. The user can also connect the PICDEM-1 board to the PICMASTER emulator and download the firmware to the emulator for testing. Additional prototype area is available for the user to build some additional hardware and connect it to the microcontroller socket(s). Some of the features include an RS-232 interface, a potentiometer for simulated analog input, push-button switches and eight LEDs connected to PORTB.

16.7 PICDEM-2 Low-Cost PIC16CXX Demonstration Board

The PICDEM-2 is a simple demonstration board that supports the PIC16C62, PIC16C64, PIC16C65, PIC16C73 and PIC16C74 microcontrollers. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-2 board, on a PRO MATE II programmer or PICSTART-16C, and easily test firmware. The PICMASTER emulator may also be used with the PICDEM-2 board to test firmware. Additional prototype area has been provided to the user for adding additional hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push-button switches, a potentiometer for simulated analog input, a Serial EEPROM to demonstrate usage of the I²C bus and separate headers for connection to an LCD module and a keypad.

16.8 PICDEM-3 Low-Cost PIC16CXXX Demonstration Board

The PICDEM-3 is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with a LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-3 board, on a PRO MATE II programmer or PICSTART Plus with an adapter socket, and easily test firmware. The PICMASTER emulator may also be used with the PICDEM-3 board to test firmware. Additional prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features

include an RS-232 interface, push-button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM-3 board is an LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM-3 provides an additional RS-232 interface and Windows 3.1 software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals. PICDEM-3 will be available in the 3rd quarter of 1996.

16.9 MPLAB Integrated Development Environment Software

The MPLAB IDE Software brings an ease of software development previously unseen in the 8-bit microcontroller market. MPLAB is a windows based application which contains:

- A full featured editor
- Three operating modes
 - editor
 - emulator
 - simulator
- A project manager
- Customizable tool bar and key mapping
- A status bar with project information
- Extensive on-line help

MPLAB allows you to:

- Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PIC16/17 tools (automatically updates all project information)
- Debug using:
 - source files
 - absolute listing file
- Transfer data dynamically via DDE (soon to be replaced by OLE)
- Run up to four emulators on the same PC

The ability to use MPLAB with Microchip's simulator allows a consistent platform and the ability to easily switch from the low cost simulator to the full featured emulator with minimal retraining due to development tools.

16.10 Assembler (MPASM)

The MPASM Universal Macro Assembler is a PC-hosted symbolic assembler. It supports all microcontroller series including the PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX, and PIC17CXX families.

MPASM offers full featured Macro capabilities, conditional assembly, and several source and listing formats. It generates various object code formats to support Microchip's development tools as well as third party programmers.

TABLE 16-1: DEVELOPMENT TOOLS FROM MICROCHIP

Product	** MPLAB™ Integrated Development Environment	MPLAB™ C Compiler	MP-DriveWay Applications Code Generator	fuzzyTECH®-MP Explorer/Edition Fuzzy Logic Dev. Tool	*** PICMASTER®/PICMASTER-CE In-Circuit Emulator	ICEPIC Low-Cost In-Circuit Emulator	****PRO MATE™ II Universal Microchip Programmer	PICSTART® Lite Ultra Low-Cost Dev. Kit	PICSTART® Plus Low-Cost Universal Dev. Kit
PIC12C508, 509	SW007002	SW006005	—	—	EM167015/ EM167101	—	DV007003	—	DV003001
PIC14000	SW007002	SW006005	—	—	EM147001/ EM147101	—	DV007003	—	DV003001
PIC16C52, 54, 54A, 55, 56, 57, 58A	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167015/ EM167101	EM167201	DV007003	DV162003	DV003001
PIC16C554, 556, 558	SW007002	SW006005	—	DV005001/ DV005002	EM167033/ EM167113	—	DV007003	—	DV003001
PIC16C61	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167021/ N/A	EM167205	DV007003	DV162003	DV003001
PIC16C62, 62A, 64, 64A	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167025/ EM167103	EM167203	DV007003	DV162002	DV003001
PIC16C620, 621, 622	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167023/ EM167109	EM167202	DV007003	DV162003	DV003001
PIC16C63, 65, 65A, 73, 73A, 74, 74A	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167025/ EM167103	EM167204	DV007003	DV162002	DV003001
PIC16C642, 662*	SW007002	SW006005	—	—	EM167035/ EM167105	—	DV007003	DV162002	DV003001
PIC16C71	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167027/ EM167105	EM167205	DV007003	DV162003	DV003001
PIC16C710, 711	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167027/ EM167105	—	DV007003	DV162003	DV003001
PIC16C72	SW007002	SW006005	SW006006	—	EM167025/ EM167103	—	DV007003	DV162002	DV003001
PIC16F83	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167029/ EM167107	—	DV007003	DV162003	DV003001
PIC16C84	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167029/ EM167107	EM167206	DV007003	DV162003	DV003001
PIC16F84	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167029/ EM167107	—	DV007003	DV162003	DV003001
PIC16C923, 924*	SW007002	SW006005	SW006006	DV005001/ DV005002	EM167031/ EM167111	—	DV007003	—	DV003001
PIC17C42, 42A, 43, 44	SW007002	SW006005	SW006006	DV005001/ DV005002	EM177007/ EM177107	—	DV007003	—	DV003001

*Contact Microchip Technology for availability date
 **MPLAB Integrated Development Environment includes MPLAB-SIM Simulator and MPASM Assembler
 ***All PICMASTER and PICMASTER-CE ordering part numbers above include PRO MATE II programmer
 ****PRO MATE socket modules are ordered separately. See development systems ordering guide for specific ordering part numbers

Product	TRUEGAUGE® Development Kit	SEEVAL® Designers Kit	Hopping Code Security Programmer Kit	Hopping Code Security Eval/Demo Kit
All 2 wire and 3 wire Serial EEPROM's	N/A	DV243001	N/A	N/A
MTA11200B	DV114001	N/A	N/A	N/A
HCS200, 300, 301 *	N/A	N/A	PG306001	DM303001

17.1 DC CHARACTERISTICS: PIC17C42-16 (Commercial, Industrial) PIC17C42-25 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)							
DC CHARACTERISTICS							
Operating temperature							
-40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial							
Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D001	VDD	Supply Voltage	4.5	–	5.5	V	
D002	VDR	RAM Data Retention Voltage (Note 1)	1.5 *	–	–	V	Device in SLEEP mode
D003	VPOR	VDD start voltage to ensure internal Power-on Reset signal	–	VSS	–	V	See section on Power-on Reset for details
D004	SVDD	VDD rise rate to ensure internal Power-on Reset signal	0.060*	–	–	mV/ms	See section on Power-on Reset for details
D010 D011 D012 D013 D014	IDD	Supply Current (Note 2)	–	3 6 11 19 95	6 12 * 24 * 38 150	mA mA mA mA μA	FOSC = 4 MHz (Note 4) FOSC = 8 MHz FOSC = 16 MHz FOSC = 25 MHz FOSC = 32 kHz WDT enabled (EC osc configuration)
D020 D021	IPD	Power-down Current (Note 3)	–	10 < 1	40 5	μA μA	VDD = 5.5V, WDT enabled VDD = 5.5V, WDT disabled

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD or VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

Current consumed from the oscillator and I/O's driving external capacitive or resistive loads need to be considered.

For the RC oscillator, the current through the external pull-up resistor (R) can be estimated as: $V_{DD} / (2 \cdot R)$.

For capacitive loads, The current can be estimated (for an individual I/O pin) as $(C_L \cdot V_{DD}) \cdot f$

C_L = Total capacitive load on the I/O pin; f = average frequency on the I/O pin switches.

The capacitive currents are most significant when the device is configured for external execution (includes extended microcontroller mode).

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, all I/O pins in hi-impedance state and tied to VDD or VSS.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula $I_R = V_{DD}/2R_{ext}$ (mA) with Rext in kOhm.

FIGURE 18-7: TYPICAL I_{DD} vs. FREQUENCY (EXTERNAL CLOCK 25°C)

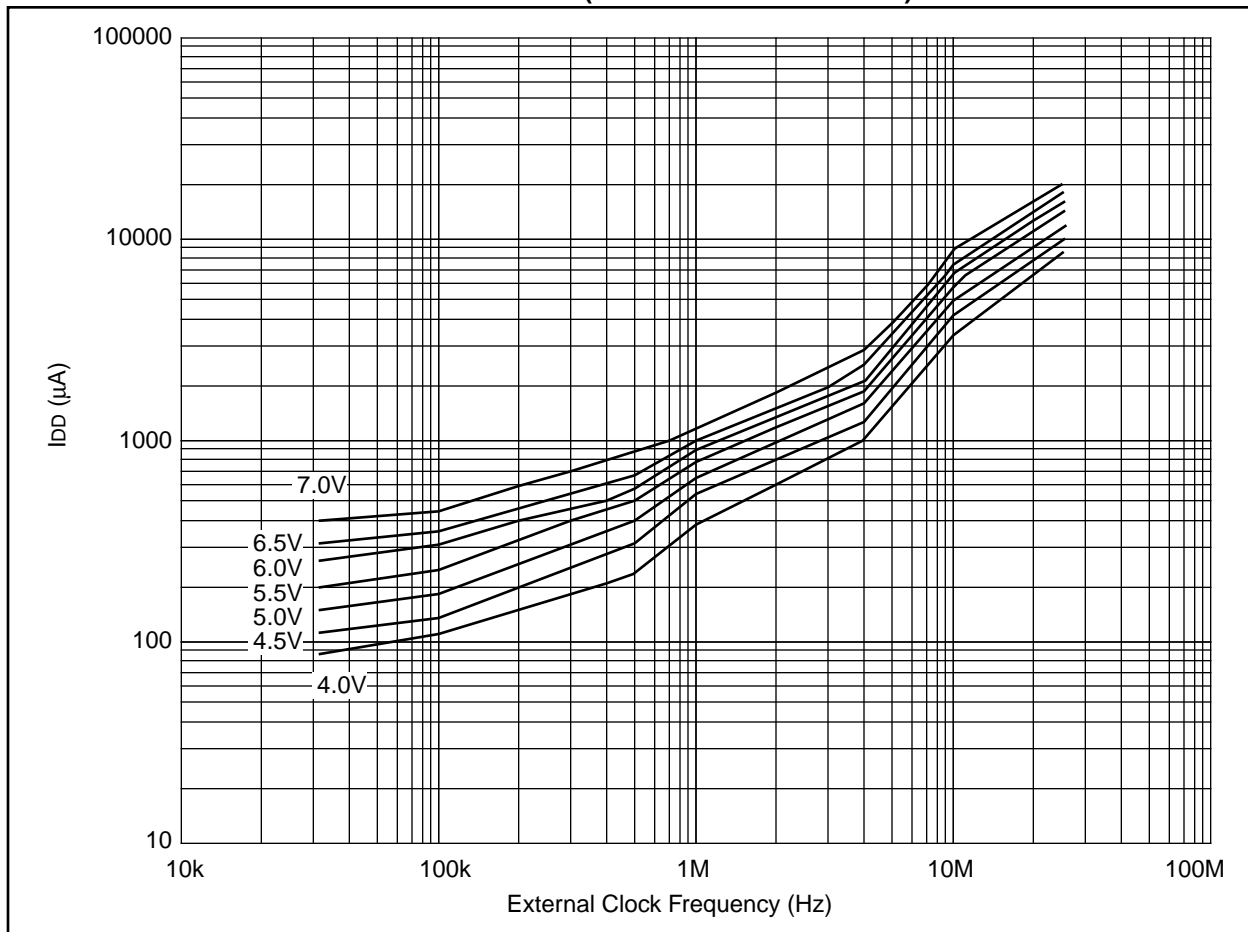
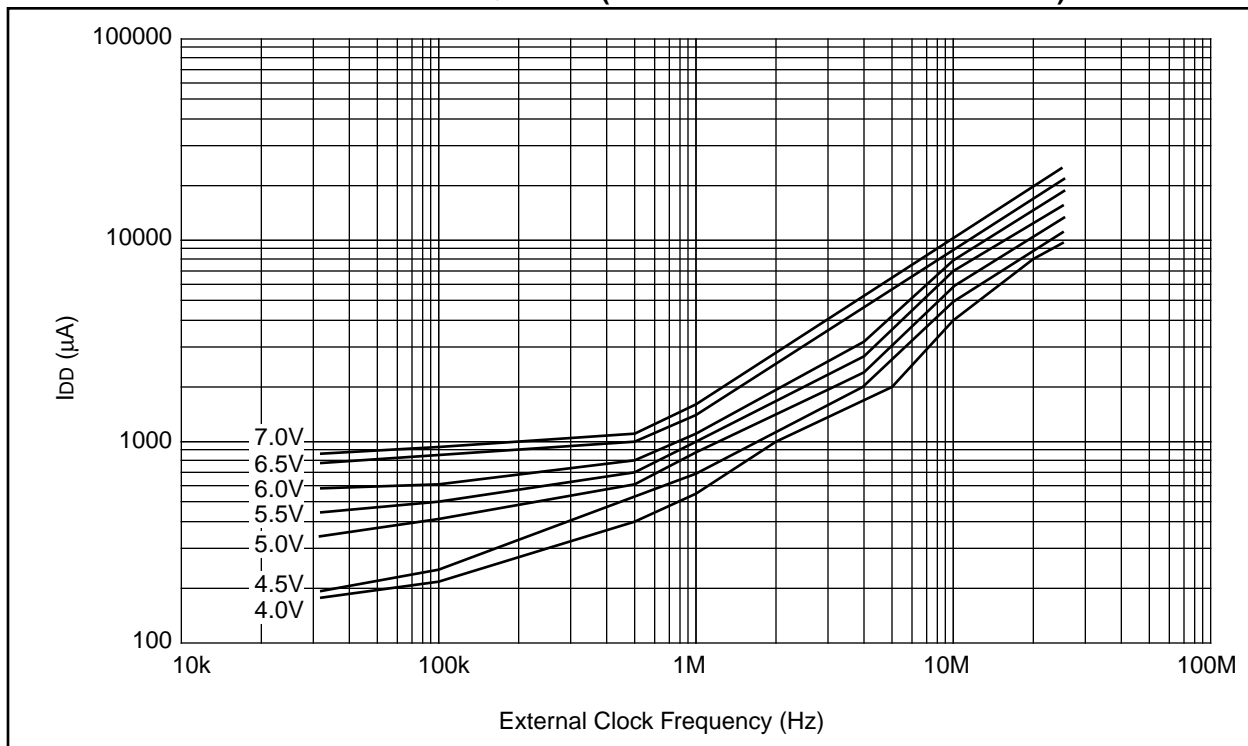


FIGURE 18-8: MAXIMUM I_{DD} vs. FREQUENCY (EXTERNAL CLOCK 125°C TO -40°C)

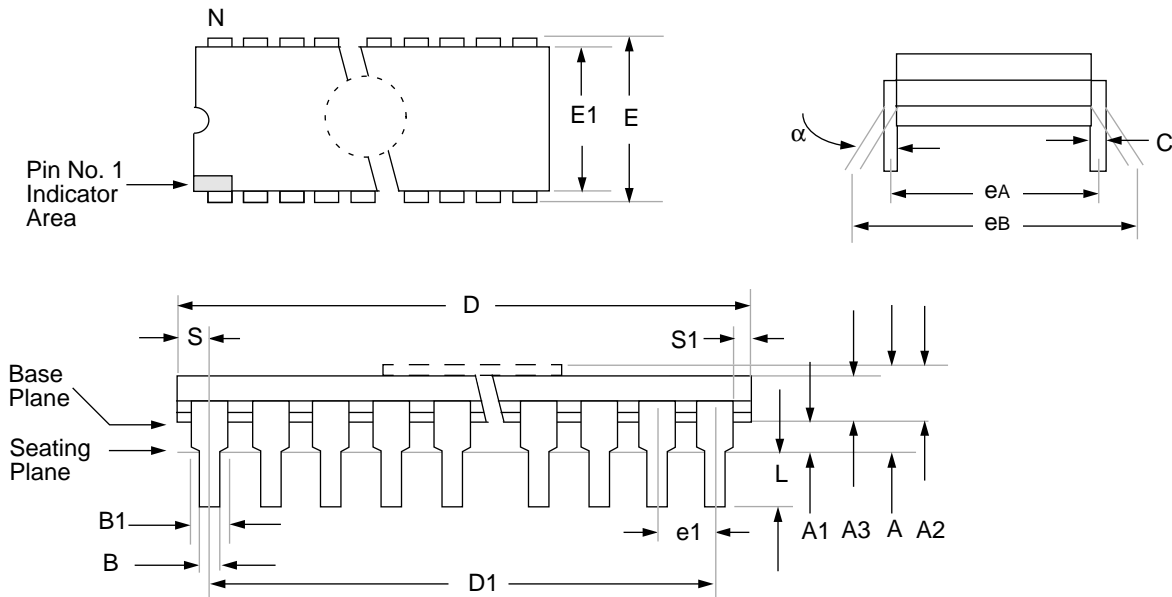


PIC17C4X

NOTES:

21.0 PACKAGING INFORMATION

21.1 40-Lead Ceramic Cerdip Dual In-line, and Cerdip Dual In-line with Window (600 mil)



Package Group: Ceramic Cerdip Dual In-Line (CDP)						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
α	0°	10°		0°	10°	
A	4.318	5.715		0.170	0.225	
A1	0.381	1.778		0.015	0.070	
A2	3.810	4.699		0.150	0.185	
A3	3.810	4.445		0.150	0.175	
B	0.355	0.585		0.014	0.023	
B1	1.270	1.651	Typical	0.050	0.065	Typical
C	0.203	0.381	Typical	0.008	0.015	Typical
D	51.435	52.705		2.025	2.075	
D1	48.260	48.260	Reference	1.900	1.900	Reference
E	15.240	15.875		0.600	0.625	
E1	12.954	15.240		0.510	0.600	
e1	2.540	2.540	Reference	0.100	0.100	Reference
eA	14.986	16.002	Typical	0.590	0.630	Typical
eB	15.240	18.034		0.600	0.710	
L	3.175	3.810		0.125	0.150	
N	40	40		40	40	
S	1.016	2.286		0.040	0.090	
S1	0.381	1.778		0.015	0.070	

APPENDIX F: ERRATA FOR PIC17C42 SILICON

The PIC17C42 devices that you have received have the following anomalies. At present there is no intention for future revisions to the present PIC17C42 silicon. If these cause issues for the application, it is recommended that you select the PIC17C42A device.

Note: New designs should use the PIC17C42A.

Design considerations

The device must not be operated outside of the specified voltage range. An external reset circuit must be used to ensure the device is in reset when a brown-out occurs or the VDD rise time is too long. Failure to ensure that the device is in reset when device voltage is out of specification may cause the device to lock-up and ignore the MCLR pin.

1. When the Oscillator Start-Up Timer (OST) is enabled (in LF or XT oscillator modes), any interrupt that wakes the processor may cause a WDT reset. This occurs when the WDT is greater than or equal to 50% time-out period when the `SLEEP` instruction is executed. This will not occur in either the EC or RC oscillator modes.

Work-arounds

- a) Always ensure that the `CLRWDT` instruction is executed before the WDT increments past 50% of the WDT period. This will keep the "false" WDT reset from occurring.
- b) When using the WDT as a normal timer (WDT disabled), ensure that the WDT is less than or equal to 50% time-out period when the `SLEEP` instruction is executed. This can be done by monitoring the \overline{TO} bit for changing state from set to clear. Example 1 shows putting the PIC17C42 to sleep.

EXAMPLE F-1: PIC17C42 TO SLEEP

```

BTFSS    CPUSTA, TO    ; TO = 0?
CLRWDT                    ; YES, WDT = 0
LOOP     BTFSC    CPUSTA, TO    ; WDT rollover?
        GOTO     LOOP          ; NO, Wait
        SLEEP                    ; YES, goto Sleep
    
```

2. When the clock source of Timer1 or Timer2 is selected to external clock, the overflow interrupt flag will be set twice, once when the timer equals the period, and again when the timer value is reset to 0h. If the latency to clear TMRxIF is greater than the time to the next clock pulse, no problems will be noticed. If the latency is less than the time to the next timer clock pulse, the interrupt will be serviced twice.

Work-arounds

- a) Ensure that the timer has rolled over to 0h before clearing the flag bit.
- b) Clear the timer in software. Clearing the timer in software causes the period to be one count less than expected.

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The following connect procedure applies in most locations.

1. Set your modem to 8-bit, No parity, and One stop (8N1). This is not the normal CompuServe setting which is 7E1.
2. Dial your local CompuServe access number.
3. Depress the <Enter> key and a garbage string will appear because CompuServe is expecting a 7E1 setting.
4. Type +, depress the <Enter> key and "Host Name:" will appear.
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